

Product Change Notification

(Notification - P1703021-DIGI)

(MC2-J-17-0017)

March 7, 2017

To: *Our Valued Digi-Key, Inc. Customer*

Overview: The purpose of this notification is to communicate a product change of select Renesas Electronics America, Inc. (REA) devices. There is no change to the part number, electrical characteristics, or product reliability.

This notification announces the addition of TSMC as a wafer fabrication facility.

Affected Products: A review of our records indicate the attached list of products may affected your company.

Booking Part Number
R5F56316CDFB#V0
R5F56316CDFP#V0
R5F56316DDFC#V0
R5F56316DDFP#V0
R5F56318CDLJ#U0
R5F56318DDFB#V0

Part numbers given in this list are for active part numbers in REA database at the time of this notification.

Key Dates:

Cross shipments from REA of product using material from the additional wafer fabrication facility begins.

December 15th, 2017

Response: No response is required. REA will consider this notification approved 30 days after its issue. If you anticipate volumes beyond your regular rate prior to the transition date, please contact your REA sales representative with a forecast of your requirements.

Please contact your REA sales representative for any questions or comments.

Thank you for your attention.

Sincerely,

Renesas Electronics America, Inc.